

## **DuPont™ Pyralux® LF-B**

#### Black Acrylic-Based Coverlay

#### Flexible Circuit Materials

#### **Product Description**

DuPont™ Pyralux® LF-B Coverlay features DuPont™ Kapton® matte black polyimide film for high performance applications where design aesthetics are critical. This product is coated on one side with a proprietary B-staged modified acrylic adhesive. This coverlay can be used to encapsulate etched details in flexible and rigid-flex multilayer constructions for environmental protection and electrical insulation. Black coverlay is also commonly used to enhance circuit aesthetics and improve LED lighting controls in specialty applications.

#### **Key Features and Benefits**

- · Color-stable matte black surface
- · Crease and scratch resistance
- · Maintains appearance through high temperature cycles
- · Certified to IPC-4203/1
- · RoHS Compliant

#### **Packaging**

Pyralux® LF-B Coverlay is supplied on 24 in (610 mm) wide by 250 ft (76 m) long rolls, on nominal 3 in (76 mm) cores. Narrower widths or cut sheets are also available by special order.

#### Storage Conditions and Warranty

Pyralux® LF-B Coverlay should be stored in the original packaging at temperatures of 4 - 29 °C (40 - 85 °F) and below 70% humidity. The product should not be frozen and should be kept dry, clean, and well-protected. Subject to compliance with the foregoing handling and storage recommendations, DuPont's warranties, as provided in the DuPont Standard Conditions of Sale, shall remain in effect for a period of two years following the date of shipment.

#### **Processing**

Lamination conditions for DuPont™ Pyralux® LF-B Coverlay flexible circuit materials are typically in the following ranges:

Part Temperature:	182 - 199 °C (360 - 390 °F)
Pressure:	14 - 28 kg/cm² (200 - 400 psi)
Time:	1 - 2 hours, at temperature

Pyralux® LF-B Coverlay processing guide available from your DuPont sales representative.

#### Table 1 - Standard Pyralux® LF-B Coverlay Offerings

Adhesive Thickness	Kapton® Thickness
μm (mil)	μm (mil)
25 (1.0)	25 (1.0)
51 (2.0)	25 (1.0)
25 (1.0)	13 (0.5)
	μm (mil) 25 (1.0) 51 (2.0)

#### Pyralux® LF-B Coverlay Construction Selection

A variety of Pyralux® LF-B Coverlay constructions are commercially available. For help beyond the standard offerings in Table 1, please use the Laminate Product Selector at pyralux.dupont.com to identify the appropriate product code for your coverlay solution.



#### Safe Handling

Prior to handling, DuPont recommends referencing the Pyralux® Safe Handling Guide available at pyralux.dupont.com.

#### **Quality and Traceability**

DuPont™ Pyralux® LF-B Coverlay is manufactured under a certified ISO9001:2015 Quality Management System facility. Complete material and manufacturing records, which include archive samples of finished product, are maintained by DuPont. Each manufactured lot is identified for reference traceability. The packaging label serves as the primary tracking mechanism in the event of customer inquiry and includes the product name, batch number, size, and quantity.

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#### **Product Performance**

#### Table 2 - DuPont™ Pyralux® LF-B Coverlay Properties

Property	LF-B0110 Typical Value	Test Method
Peel Strength* (Adhesion to Copper) As Received, N/mm (lb/in) After Solder, N/mm (lb/in)	1.8 (10.0) 1.6 (9.0)	IPC-TM-650 2.4.9
Adhesive Flow, mm (mil)	0.05 - 0.10 (2 - 4)	IPC-TM-650 2.3.17.1
Dimensional Stability (MD/TD)	± 0.04 %	IPC-TM-650 2.2.4
Solder Float, 288 °C for 10 s	Pass	IPC-TM-650 2.4.13
Volume Resistivity, Ω·cm	> 1015	IPC-TM-650 2.5.17
Surface Resistance, $\Omega$	> 10 <sup>14</sup>	IPC-TM-650 2.5.17

Data within this table are typical values for the listed product. Performance can vary depending on construction and processing.



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# For more information on DuPont™ LF-B Black Coverlay or other DuPont products, please visit our website.

The information provided in this data sheet corresponds to our knowledge on the subject at the date of its publication. It may be subject to revision as new knowledge and experience becomes available. This information is not intended to substitute for any testing you may need to conduct to determine for yourself the suitability of our products for your particular purposes. Since we cannot anticipate all variations in end-use and disposal conditions, DuPont makes no warranties and assumes no liability in connection with any use of this information. It is intended for use by persons having technical skill, at their own discretion and risk. Nothing in this publication is to be considered as a license to operate under or a recommendation to infringe any patent right.

CAUTION: Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see "DuPont Medical Caution Statement," H-50102-5 and "DuPont Policy Regarding Medical Applications" H-50103-5...

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EI-10120 (3/20)

<sup>\*</sup>Lamination Conditions: 14 kg/cm² (200 psi) at 182 °C (360 °F) for 1 hour to treated side of 1 oz RA copper foil.